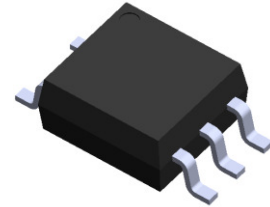


Features

- High speed 1Mbit/s
- High isolation voltage between input and output ($V_{iso}=3750 V_{rms}$)
- High CMR 15KV/us at $V_{CM}=1500V$ (ELM453)
- Guaranteed performance from 0°C to 70°C
- Wide operating temperature range of -40°C to 85°C
- Pb free and RoHS and Halogen free compliant
- cUL approved (No. E214129)
- VDE approved (No. 40028116)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved



Description

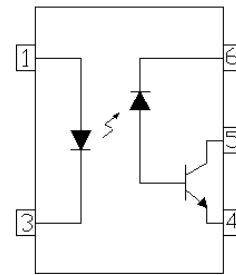
The ELM452 and ELM453 devices each consist of an infrared emitting diode, optically coupled to a high speed photo detector transistor. A separate connection for the photodiode bias and output-transistor collector increase the speed by several orders of magnitude over conventional phototransistor couplers by reducing the base-collector capacitance of the input transistor.

The devices are packaged in industry standard 5pin SOP packages and are suitable for surface mounting.

Applications

- Line receivers
- Field bus communication and control.
- Power transistor isolation in motor drives
- Replacement for low speed phototransistor photo couplers
- High speed logic ground isolation
- Analog signal ground isolation

Schematic



Pin Configuration

1. Anode
3. Cathode
4. Gnd
5. Vout
6. VCC

Absolute Maximum Ratings ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

| Parameter | | Symbol | Rating | Unit |
|-------------------------------------|--|--------------|------------|--------------------|
| Input | Forward current | I_F | 25 | mA |
| | Peak forward current (50% duty, 1ms P.W) | I_{FP} | 50 | mA |
| | Peak transient current ($\leq 1\mu\text{s}$ P.W, 300pps) | I_{Ftrans} | 1 | A |
| | Reverse voltage | V_R | 5 | V |
| | Power dissipation | P_{IN} | 45 | mW |
| Output | Power dissipation | P_O | 100 | mW |
| | Average Output current | $I_{O(AVG)}$ | 8 | mA |
| | Peak Output current | $I_{O(PK)}$ | 16 | mA |
| | Output voltage | V_O | -0.5 to 20 | V |
| | Supply voltage | V_{CC} | -0.5 to 30 | V |
| Isolation voltage ^{*1} | | V_{ISO} | 3750 | V rms |
| Operating temperature | | T_{OPR} | -40 ~ +85 | $^{\circ}\text{C}$ |
| Storage temperature | | T_{STG} | -55 ~ +125 | $^{\circ}\text{C}$ |
| Soldering temperature ^{*2} | | T_{SOL} | 260 | $^{\circ}\text{C}$ |

Notes

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1 & 3 are shorted together, and pins 4, 5 & 6 are shorted together.

*2 For 10 seconds.

Electrical Characteristics ($T_A=0$ to 70°C unless specified otherwise)

Input

| Parameter | Symbol | Min. | Typ.* | Max. | Unit | Conditions |
|--|-------------------------|------|-------|------|----------------------|-----------------------|
| Forward voltage | V_F | - | 1.45 | 1.8 | V | $I_F = 16\text{mA}$ |
| Reverse Voltage | V_R | 5.0 | - | - | V | $I_R = 10\mu\text{A}$ |
| Temperature coefficient of forward voltage | $\Delta V_F/\Delta T_A$ | - | -1.6 | - | mV/ $^\circ\text{C}$ | $I_F = 16\text{mA}$ |

Output

| Parameter | Symbol | Min. | Typ.* | Max. | Unit | Conditions |
|---------------------------|-----------|------|-------|------|---------------|---|
| Logic High Output Current | I_{OH} | - | 0.001 | 0.5 | μA | $I_F = 0\text{mA}$, $V_O = V_{CC} = 5.5\text{V}$, $T_A = 25^\circ\text{C}$ |
| | | - | 0.001 | 1 | | $I_F = 0\text{mA}$, $V_O = V_{CC} = 15\text{V}$, $T_A = 25^\circ\text{C}$ |
| | | - | - | 50 | | $I_F = 0\text{mA}$, $V_O = V_{CC} = 15\text{V}$ |
| Logic Low Supply Current | I_{CCL} | - | 100 | 200 | μA | $I_F = 16\text{mA}$, $V_O = \text{Open}$, $V_{CC} = 15\text{V}$ |
| Logic High Supply Current | I_{CCH} | - | 0.05 | 1 | μA | $I_F = 0\text{mA}$, $V_O = \text{Open}$, $V_{CC} = 15\text{V}$, $T_A = 25^\circ\text{C}$ |
| | | - | - | 2 | | $I_F = 0\text{mA}$, $V_O = \text{Open}$, $V_{CC} = 15\text{V}$ |

Transfer Characteristics

| Parameter | Symbol | Min. | Typ.* | Max. | Unit | Conditions |
|--------------------------|----------|------|-------|------|------|---|
| Current Transfer Ratio | CTR | 20 | - | 50 | % | $I_F = 16\text{mA}$, $V_O = 0.4\text{V}$, $V_{CC} = 4.5\text{V}$, $T_A = 25^\circ\text{C}$ |
| | | 15 | - | - | | $I_F = 16\text{mA}$, $V_O = 0.5\text{V}$, $V_{CC} = 4.5\text{V}$ |
| Logic Low Output Voltage | V_{OL} | - | - | 0.4 | V | $I_F = 16\text{mA}$, $I_O = 3\text{mA}$, $V_{CC} = 4.5\text{V}$, $T_A = 25^\circ\text{C}$ |
| | | - | - | 0.5 | | $I_F = 16\text{mA}$, $I_O = 2.4\text{mA}$, $V_{CC} = 4.5\text{V}$ |

Switching Characteristics ($T_A=0$ to 70°C unless specified otherwise, $V_{CC}=5\text{V}$)

| Parameter | Symbol | Min. | Typ.* | Max. | Unit | Conditions | |
|--|-----------|--------|--------|------|---------------|--|--|
| Propagation Delay Time to Logic Low ^(*3) (Fig.8) | T_{PHL} | - | 0.4 | 0.8 | μs | $I_F=16\text{mA}$, $R_L=1.9\text{K}\Omega$, $T_A=25^\circ\text{C}$ | |
| | | - | - | 1.0 | | $I_F=16\text{mA}$, $R_L=1.9\text{K}\Omega$ | |
| Propagation Delay Time to Logic High ^(*3) (Fig.8) | T_{PLH} | - | 0.35 | 0.8 | μs | $I_F=16\text{mA}$, $R_L=1.9\text{K}\Omega$, $T_A=25^\circ\text{C}$ | |
| | | - | - | 1.0 | | $I_F=16\text{mA}$, $R_L=1.9\text{K}\Omega$ | |
| Common Mode Transient Immunity at Logic High ^(*4) (Fig.9) | ELM452 | CM_H | 5,000 | - | - | $V/\mu\text{s}$ | $I_F = 0\text{mA}$, $V_{CM}=10\text{Vp-p}$, $R_L=1.9\text{K}\Omega$, $T_A = 25^\circ\text{C}$ |
| | ELM453 | | 15,000 | - | - | | $I_F = 0\text{mA}$, $V_{CM}=1500\text{Vp-p}$, $R_L=1.9\text{K}\Omega$, $T_A = 25^\circ\text{C}$ |
| Common Mode Transient Immunity at Logic Low ^(*4) (Fig.9) | ELM452 | CM_L | 5,000 | - | - | $V/\mu\text{s}$ | $I_F = 16\text{mA}$, $V_{CM}=10\text{Vp-p}$, $R_L=1.9\text{K}\Omega$, $T_A = 25^\circ\text{C}$ |
| | ELM453 | | 15,000 | - | - | | $I_F = 16\text{mA}$, $V_{CM}=1500\text{Vp-p}$, $R_L=1.9\text{K}\Omega$, $T_A=25^\circ\text{C}$ |

Typical Performance Curves

Figure 1. Forward Current vs Forward Voltage

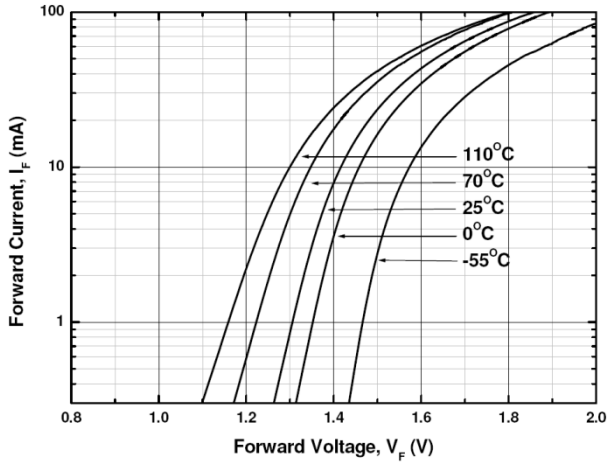


Figure 2. Current Transfer Ratio vs Forward Current

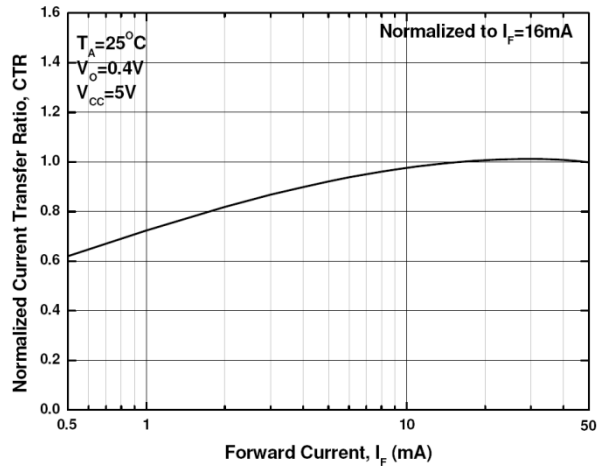


Figure 3. Current Transfer Ratio vs Ambient Temperature

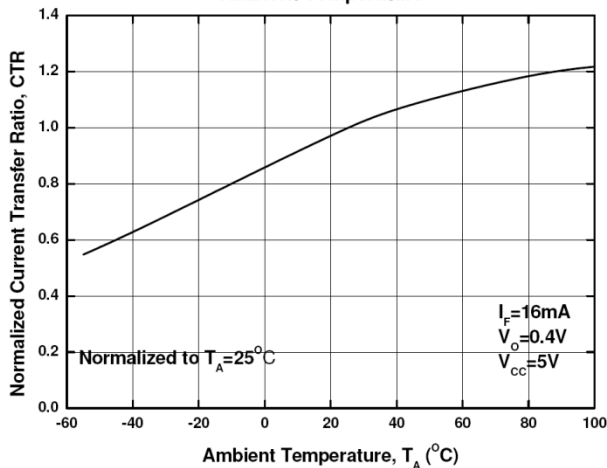


Figure 4. Output Current vs Output Voltage

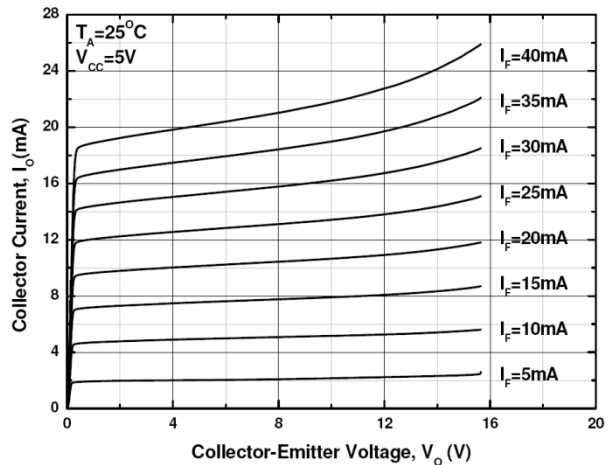


Figure 5. Logic High Output Current vs Ambient Temperature

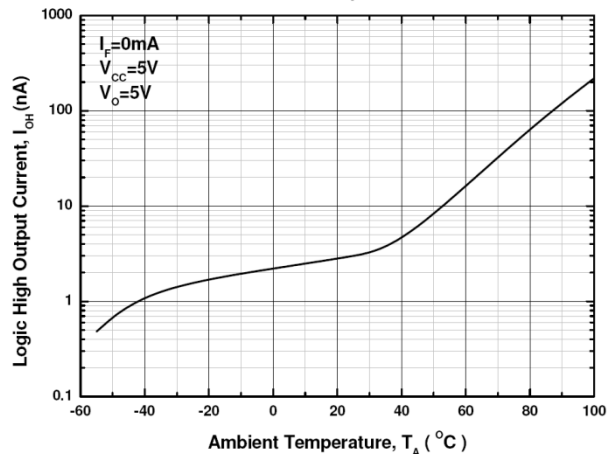


Figure 6. Propagation Delay vs. Load Resistance

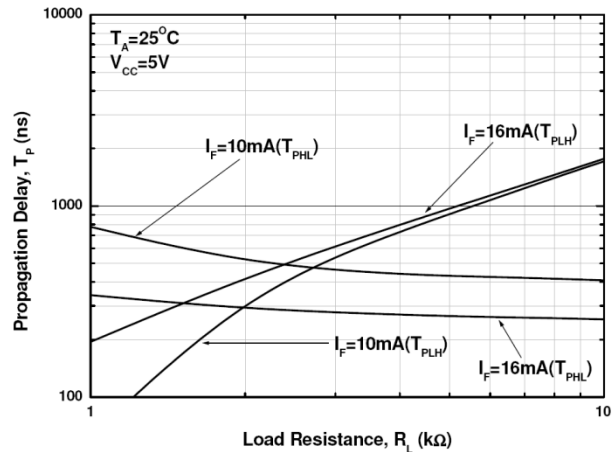


Figure 7. Propagation Delay vs. Temperature

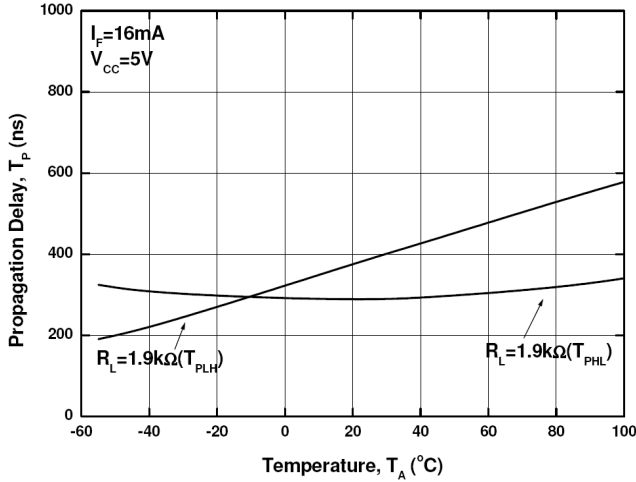


Figure 8. Frequency Response

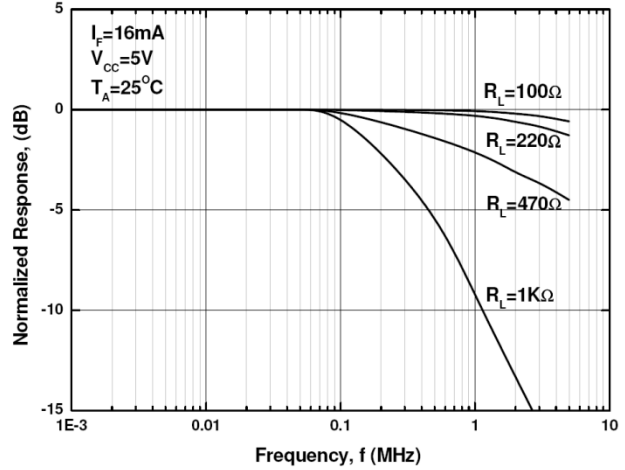


Figure 9 Switching Time Test Circuit & Waveform

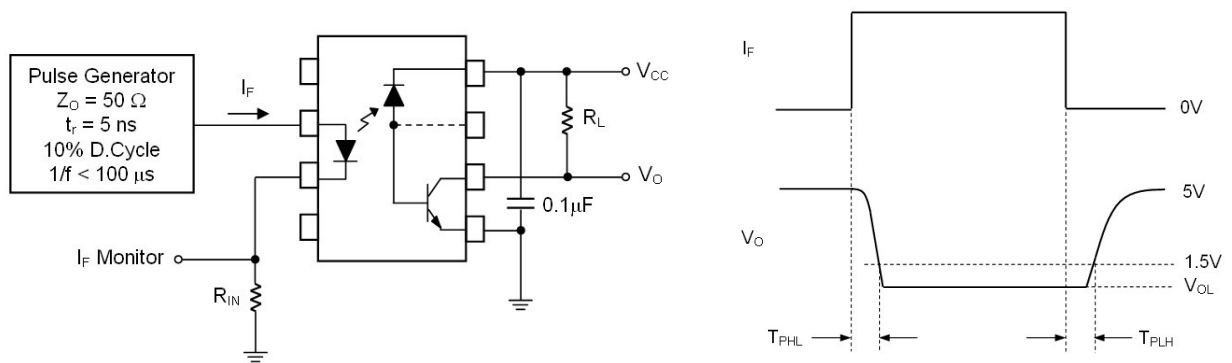
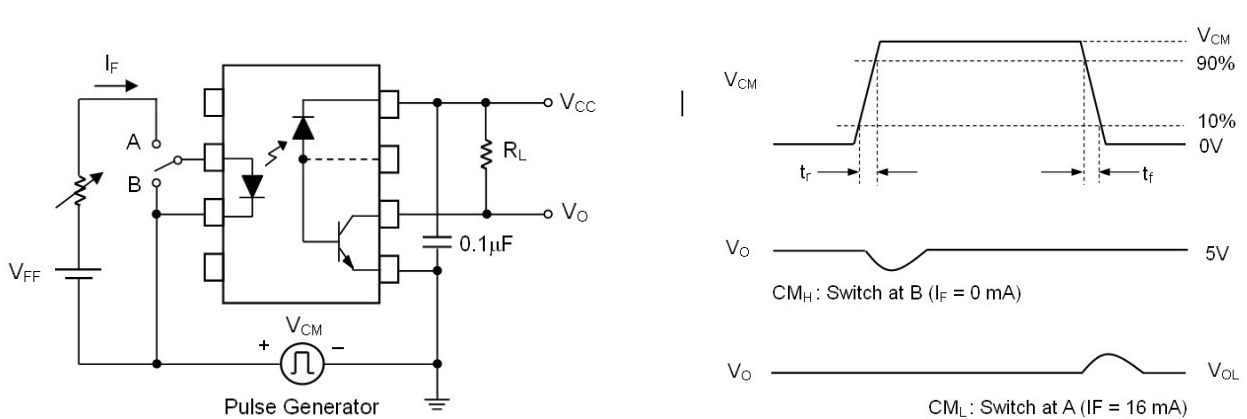


Figure 10 Transient Immunity Test Circuit & Waveform



Note:

*3 Common mode transient immunity in logic high level is the maximum tolerable (positive) dV_{cm}/dt on the leading edge of the common mode pulse signal VCM, to assure that the output will remain in a logic high state (i.e., $V_O > 2.0V$).

Common mode transient immunity in logic low level is the maximum tolerable (negative) dV_{cm}/dt on the trailing edge of the common mode pulse signal, VCM, to assure that the output will remain in a logic low state (i.e., $V_O < 0.8V$).

Order Information

Part Number

ELM45X(Z)-V

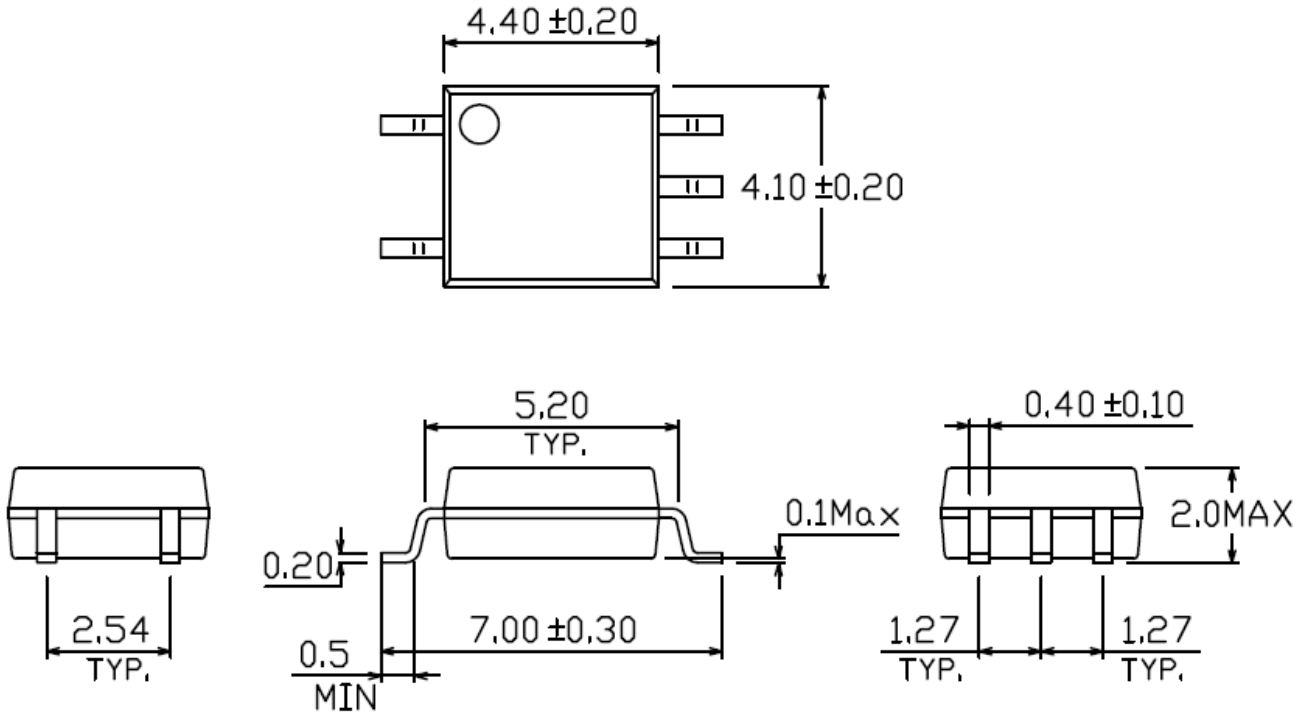
Note

- X = Part No. (2 or 3)
- Z = Tape and reel option (TA, TB or none)
- V = VDE (optional)

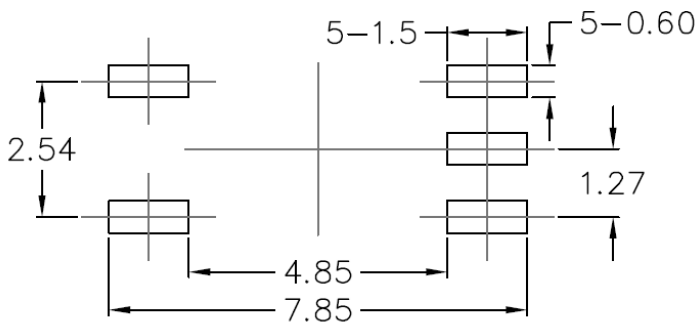
| Option | Description | Packing quantity |
|--------|-----------------------------|---------------------|
| None | Standard | 100 units per tube |
| -V | Standard + VDE | 100 units per tube |
| (TA) | TA tape & reel option | 3000 units per reel |
| (TB) | TB tape & reel option | 3000 units per reel |
| (TA)-V | TA tape & reel option + VDE | 3000 units per reel |
| (TB)-V | TB tape & reel option + VDE | 3000 units per reel |

Package Drawing

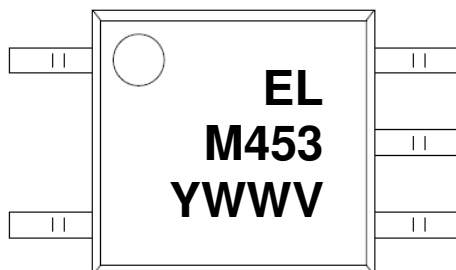
(Dimensions in mm)



Recommended pad layout for surface mount leadform



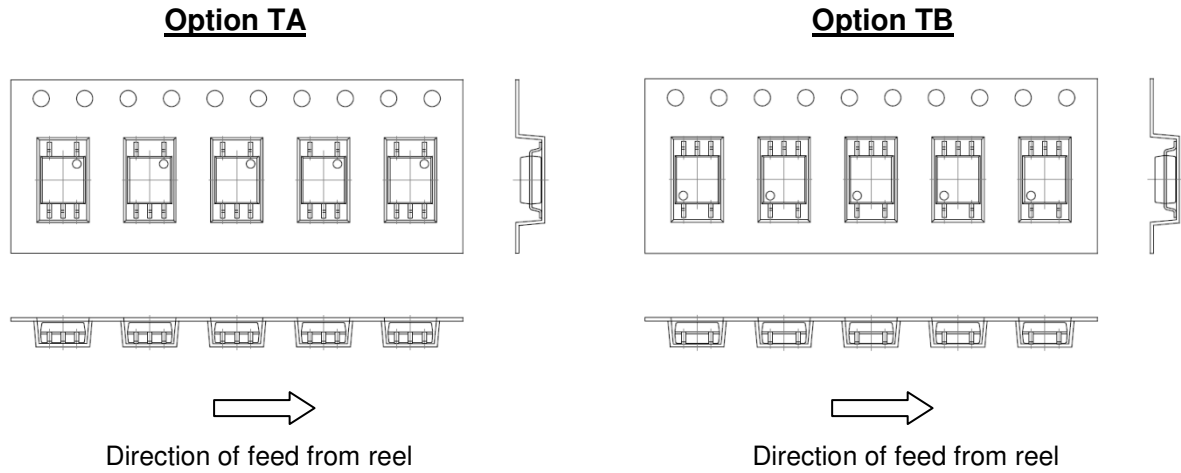
Device Marking



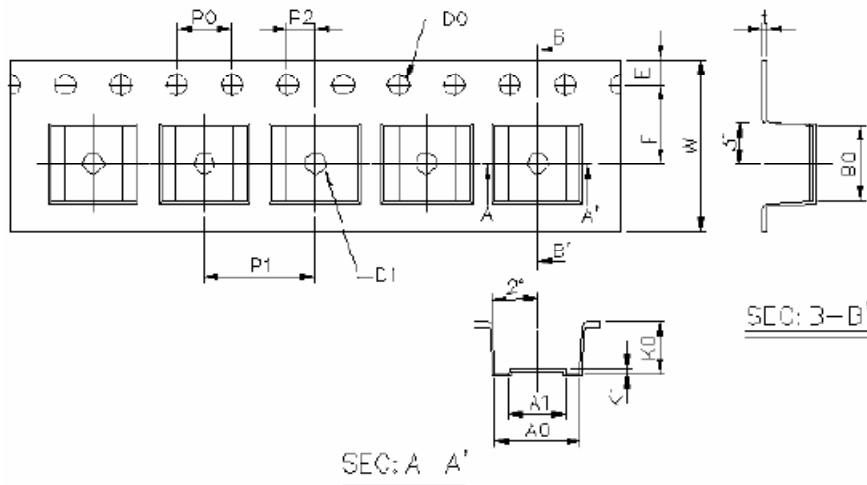
Notes

| | |
|------|---------------------------|
| EL | denotes EVERLOGHT |
| M453 | denotes Device Number |
| Y | denotes 1 digit Year code |
| WW | denotes 2 digit Week code |
| V | denotes VDE (optional) |

Tape & Reel Packing Specifications

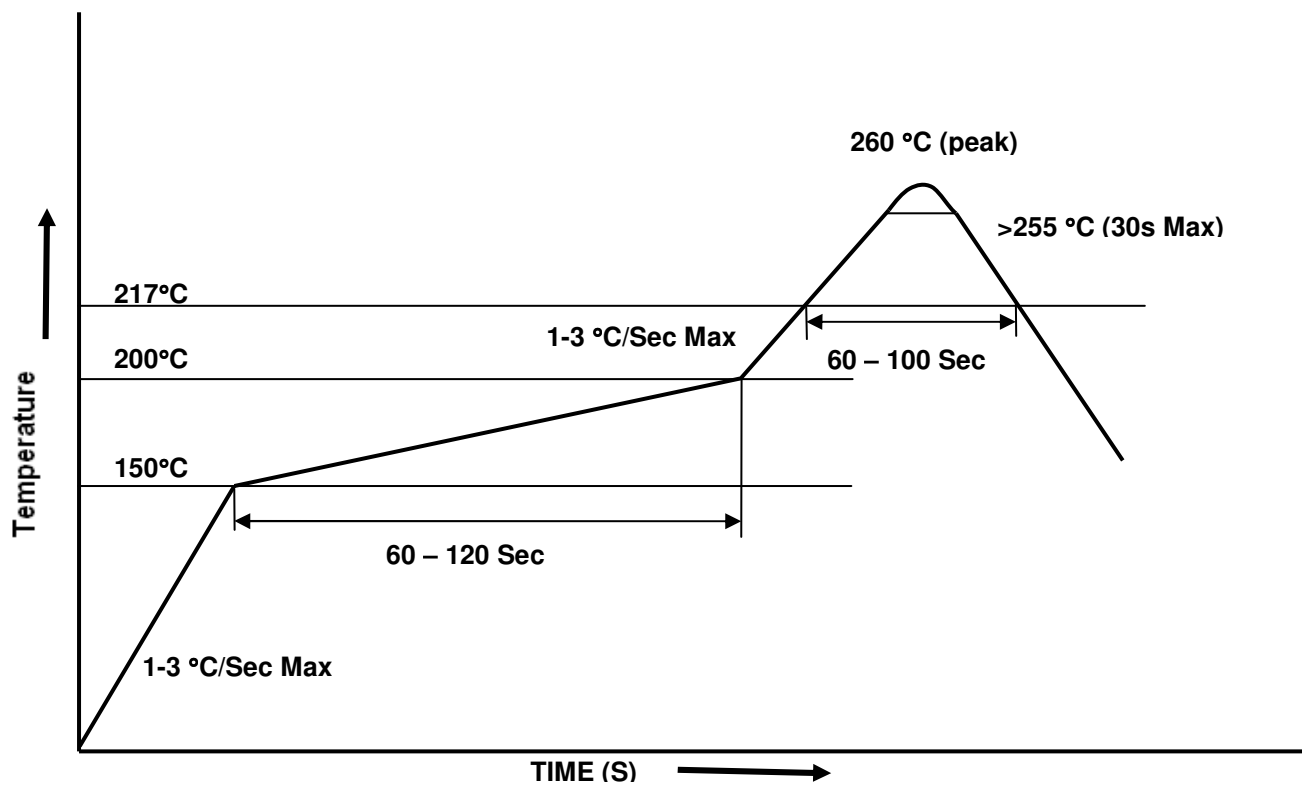


Tape dimensions



| | | | | | | | |
|---------------|-----------|-----------|-----------|-----------|-------------------|-----------|-----------|
| Dimension No. | A0 | A1 | B0 | D0 | D1 | E | F |
| Dimension(mm) | 6.2±0.1 | 4.1±0.1 | 5.28±0.1 | 1.5±0.1 | 1.5±0.3 | 1.75±0.1 | 5.5±0.1 |
| Dimension No. | Po | P1 | P2 | t | W | K0 | K1 |
| Dimension(mm) | 4.0±0.1 | 8.0±0.1 | 2.0±0.1 | 0.4±0.1 | 12.0+0.3/ -0.1 | 3.7±0.1 | 0.3±0.1 |

Solder Reflow Temperature Profile



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